

ESI120N80R1V

ev™ Automotive Grade Silicon Carbide Power MOSFET 1200V, 30A, 80mΩ

Features

- High switching speed with a low gate charge
- Very fast diode with low reverse recovery
- Robust Avalanche Capability
- 100% Avalanche Tested
- Easy to Parallel and Simple to Drive
- Pb-free, Halogen Free, and RoHS Compliant
- Qualified to AEC-Q101

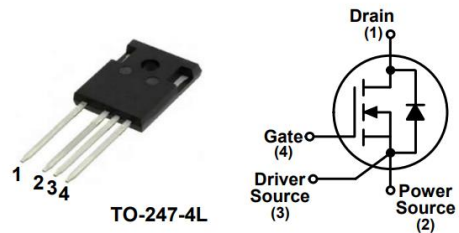
Benefits

- Higher System Efficiency
- Higher Frequency Applicability
- Increased Power Density
- Reduced Cooling Requirements

Applications

- On-board Charger/PFC
- DC-DC Converter
- Auxiliary Inverter

V _{DSS}	I _D , T _C =25°C	R _{DS(on)} , Typ.	Q _g , Typ.
1200V	30A	80mΩ	51nC



Ordering Information

Part Number	Package	Shipping	Quantity
ESI120N80R1V	TO-247-4L	Tube	30 units

■ Absolute Maximum Ratings (T_C=25°C, unless otherwise specified)

Symbol	Parameter	Value	Unit	
V _{DSS}	Drain to Source Voltage	1200	V	
V _{GS}	Gate to Source Voltage (DC)	-10/+22		
V _{GSop}	Recommended Operation Values of Gate to Source Voltage	-5/+18		
I _D	Continuous Drain Current	T _C =25°C	30	A
		T _C =100°C	21	
I _{DM}	Pulsed Drain Current (Note1)	T _C =25°C	80	
P _D	Power Dissipation	T _C =25°C	150	W
		T _C =100°C	75	W
T _J , T _{STG}	Operating and Storage Temperature Range	-55 to 175	°C	
T _L	Maximum Lead Temperature for Soldering, 1/8" from Case for 10 Seconds	260	°C	

Note1: Limited by maximum junction temperature.

■ Thermal Characteristics

Symbol	Parameter	Value	Unit
$R_{\theta JC}$	Maximum Thermal Resistance, Junction to Case	1.00	°C/W
$R_{\theta JA}$	Maximum Thermal Resistance, Junction to Ambient	40	

■ Electrical Characteristics ($T_C=25^\circ\text{C}$, unless otherwise specified)

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
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Off Characteristics

V_{DSS}	Drain to Source Breakdown Voltage	$V_{GS}=0V, I_D=1mA$	1200			V
I_{DSS}	Zero Gate Voltage Drain Current	$V_{DS}=1200V, V_{GS}=0V$		1	100	μA
		$V_{DS}=1200V, V_{GS}=0V, T_J=175^\circ\text{C}$		5		
I_{GSS}	Gate-Source Leakage Current	$V_{GS}=+22V, V_{DS}=0V$			+100	nA
		$V_{GS}=-10V, V_{DS}=0V$			-100	

On Characteristics

$V_{GS(th)}$	Gate Threshold Voltage	$V_{GS}=V_{DS}, I_D=5.0mA$	2.0	3.0	4.5	V
$R_{DS(on)}$	Static Drain to Source On Resistance	$V_{GS}=18V, I_D=15A$		80	110	m Ω
		$V_{GS}=18V, I_D=15A, T_J=175^\circ\text{C}$		128		
g_{fs}	Transconductance	$V_{DS}=20V, I_D=15A$		11.4		S

Dynamic Characteristics

C_{iss}	Input Capacitance	$V_{DS}=800V, V_{GS}=0V, f=250kHz$		885		μF
C_{oss}	Output Capacitance			65		
C_{rss}	Reverse Capacitance			5		
E_{oss}	Stored Energy in Output Capacitance	$V_{DS}=0V$ to $800V, V_{GS}=0V$		26		μJ
$Q_{g(tot)}$	Total Gate Charge	$V_{DS}=800V, I_D=15A,$ $V_{GS}=-5V/18V,$ Inductive load		51		nC
Q_{gs}	Gate to Source Charge			13		
Q_{gd}	Gate to Drain "Miller" Charge			17		
R_G	Internal Gate Resistance	$f=1MHz$		4.0		Ω

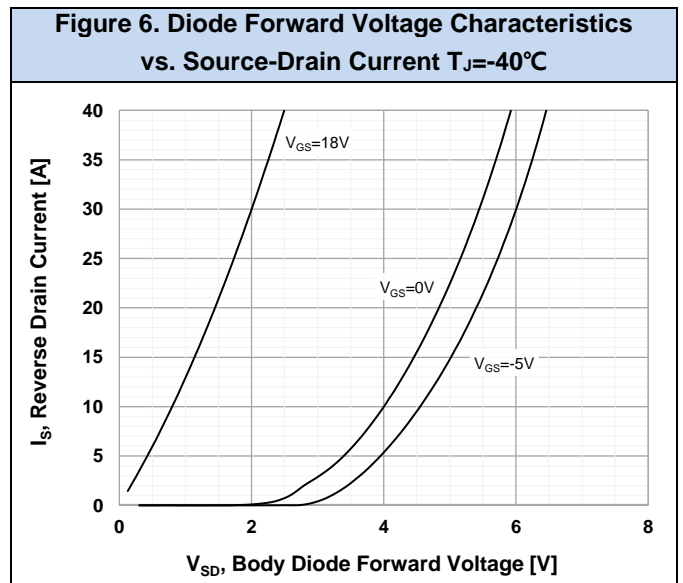
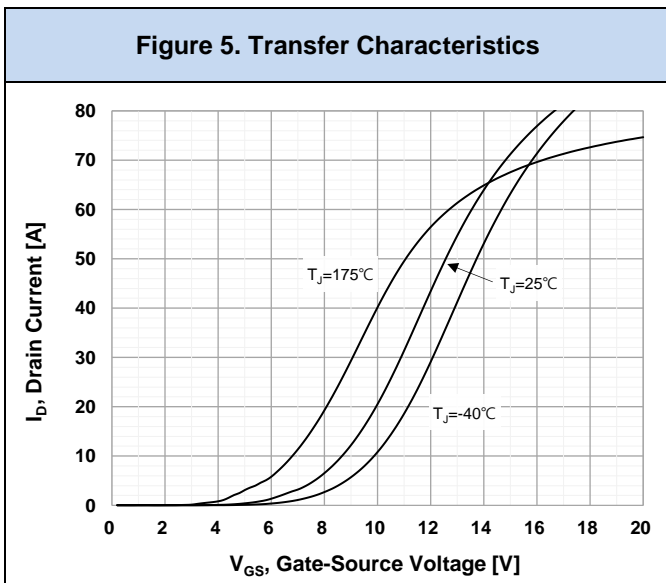
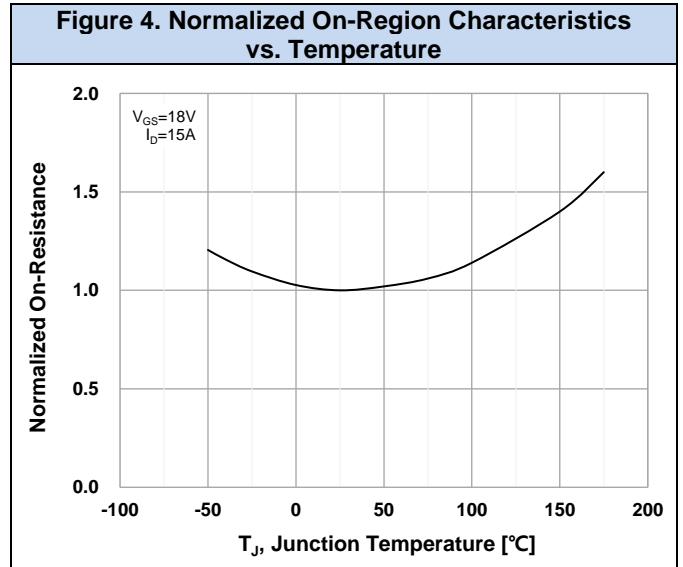
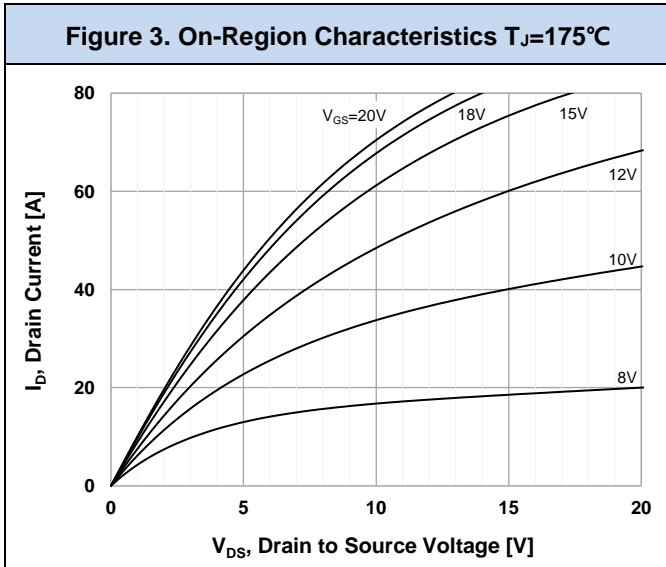
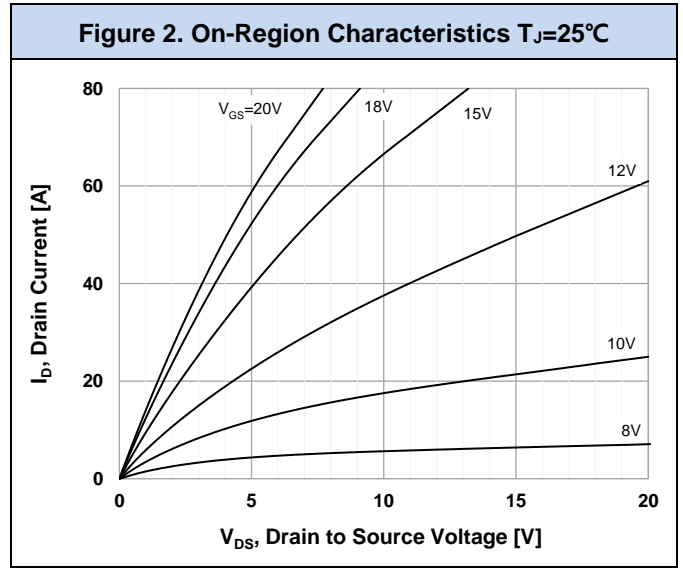
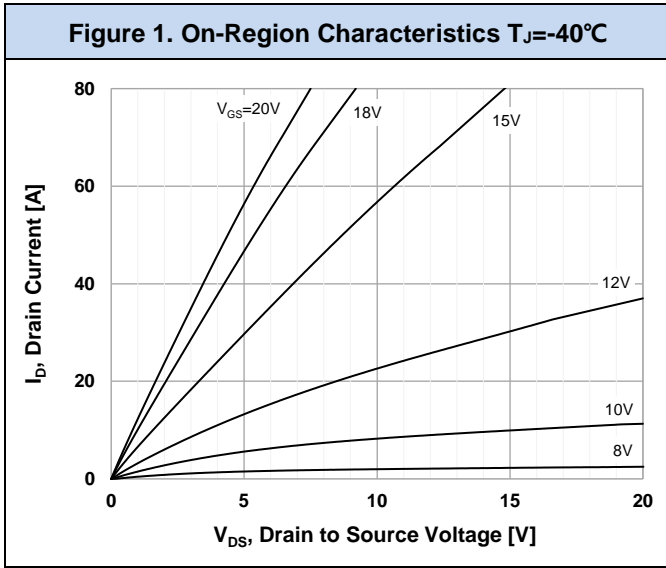
Switching Characteristics

$t_{d(on)}$	Turn-On Delay Time	$V_{DS}=800V, I_D=15A,$ $V_{GS}=-5V/18V, R_G=2\Omega,$ Inductive load		14		ns
t_r	Turn-On Rise Time			9		
$t_{d(off)}$	Turn-Off Delay Time			24		
t_f	Turn-Off Fall Time			8		
E_{on}	Turn-On Switching Energy			97		μJ
E_{off}	Turn-Off Switching Energy			48		
E_{tot}	Total Switching Energy			145		

■ **Reverse Diode Characteristics** ($T_C=25^{\circ}\text{C}$, unless otherwise specified)

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
I_S	Continuous Diode Forward Current	$V_{GS}=-5V$			30	A
I_{SM}	Pulsed Diode Forward Current	$V_{GS}=-5V$			80	
V_{SD}	Diode Forward Voltage	$V_{GS}=-5V, I_{SD}=15A$		4.1		V
		$V_{GS}=-5V, I_{SD}=15A, T_J=175^{\circ}\text{C}$		3.6		
t_{rr}	Reverse Recovery Time	$V_{DD}=800V, I_{SD}=15A, V_{GS}=-5V, dI_S/dt=1000A/\mu s$		32		ns
Q_{rr}	Reverse Recovery Charge			112		nC
E_{rec}	Reverse Recovery Energy			6.5		μJ
I_{rrm}	Peak Reverse Recovery Current			8.0		A

■ **Typical Characteristics** ($T_J=25^{\circ}\text{C}$ unless otherwise noted)



■ Typical Characteristics

Figure 7. Diode Forward Voltage Characteristics vs. Source-Drain Current $T_J=25^\circ\text{C}$

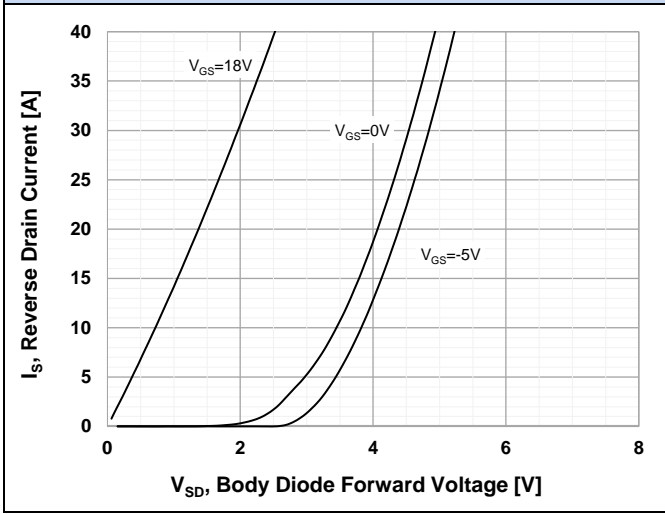


Figure 8. Diode Forward Voltage Characteristics vs. Source-Drain Current $T_J=175^\circ\text{C}$

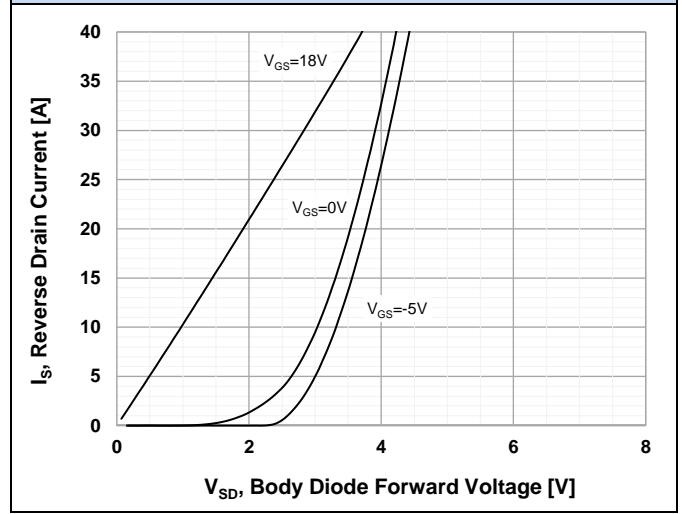


Figure 9. Threshold Voltage vs. Temperature

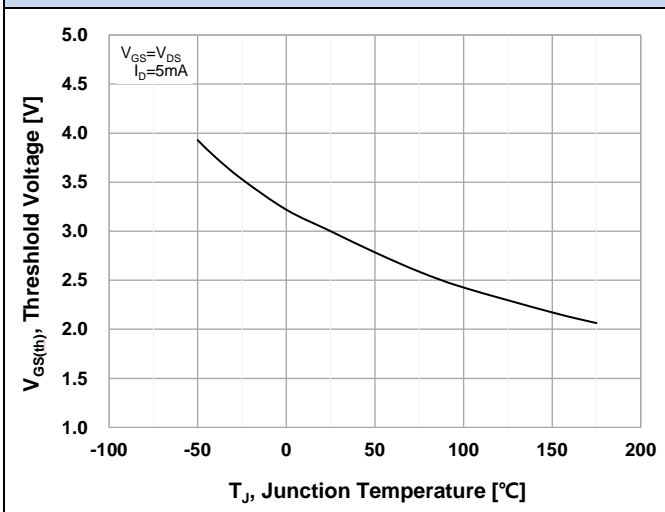


Figure 10. Gate Charge Characteristics

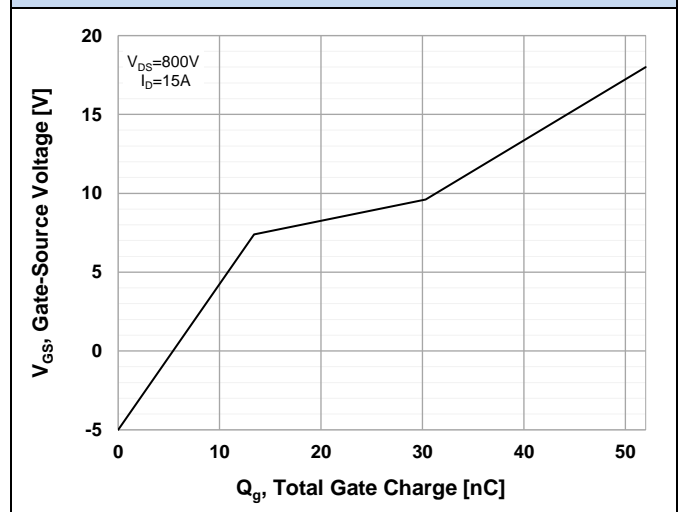


Figure 11. Stored Energy in Output Capacitance

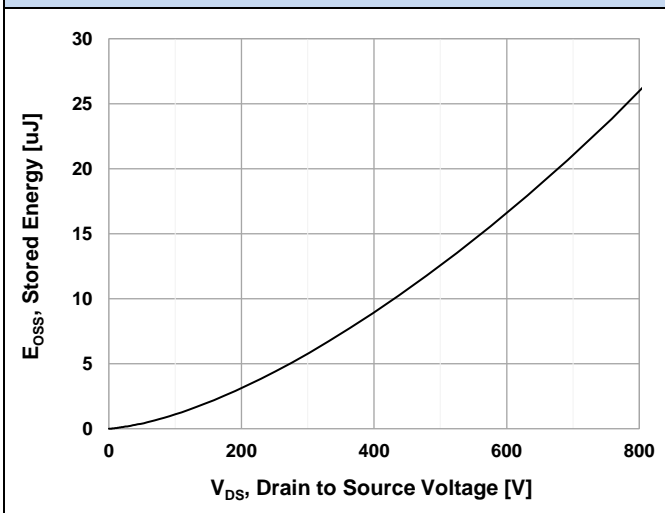
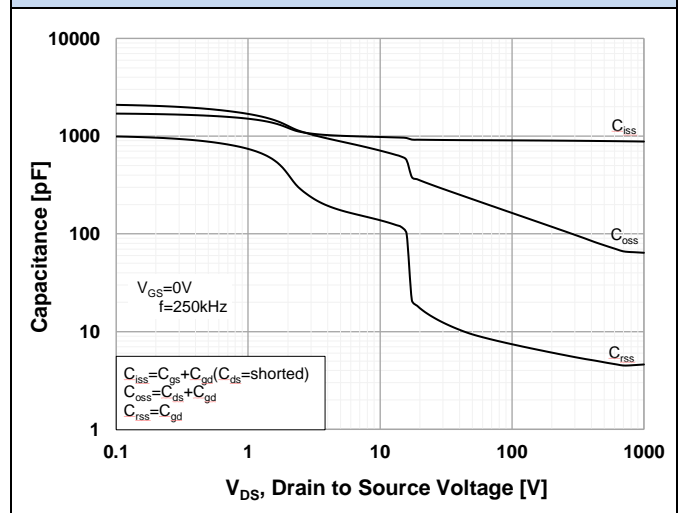


Figure 12. Capacitance Characteristics



■ Typical Characteristics

Figure 13. Continuous Drain Current Derating vs. Case Temperature

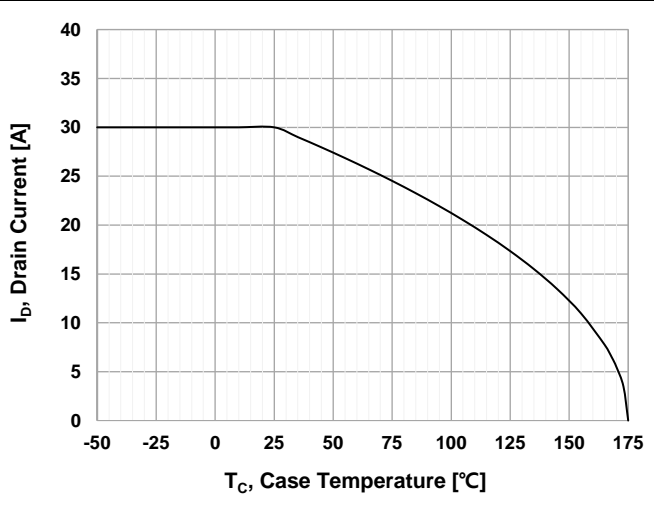


Figure 14. Maximum Power Dissipation Derating vs. Case Temperature

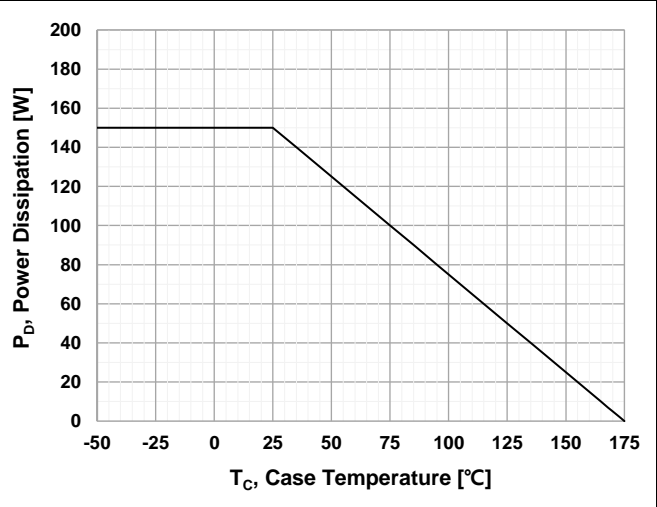


Figure 15. Typ. Switching Loss vs. Drian Current

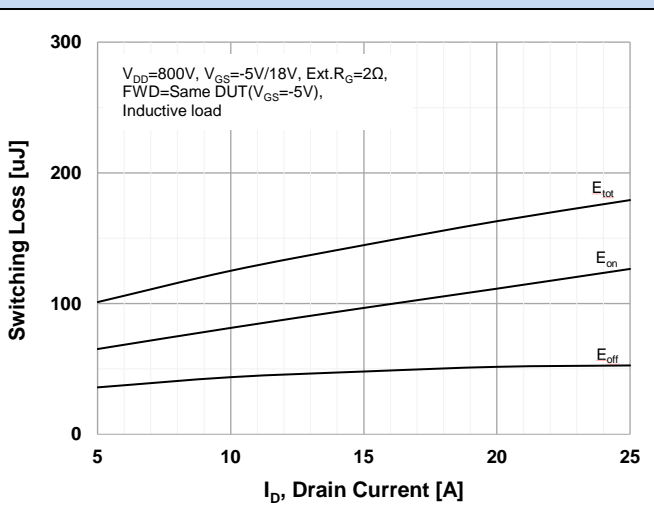


Figure 16. Typ. Switching Loss vs. Gate Resistance

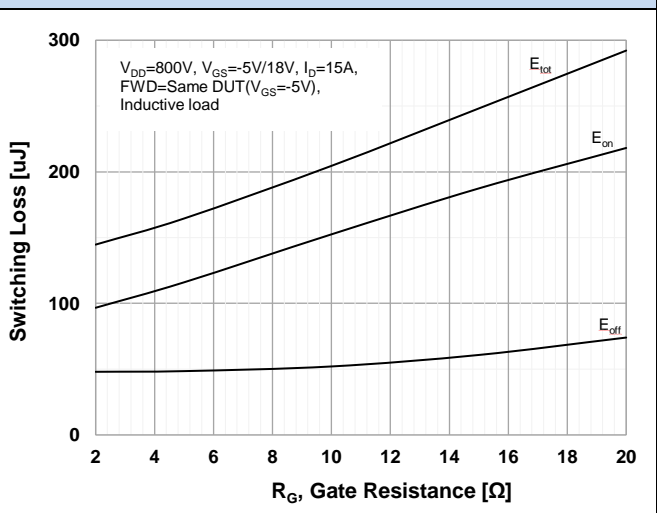


Figure 17. Maximum Safe Operating Area

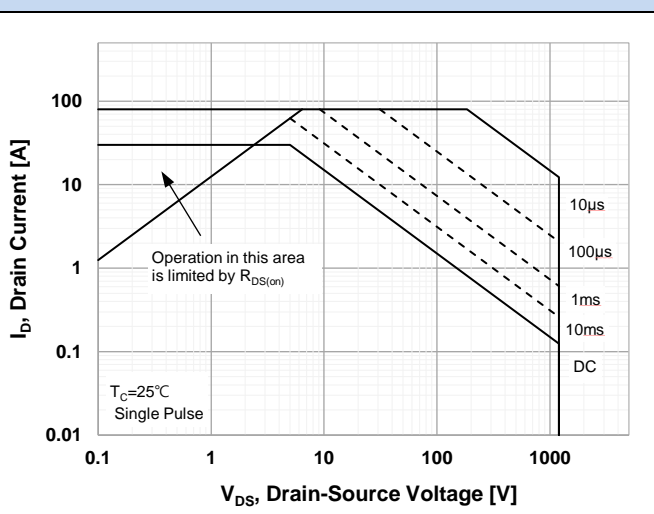
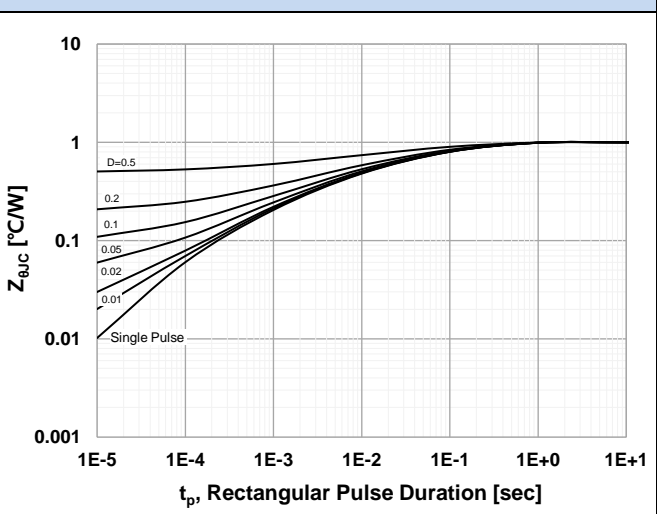
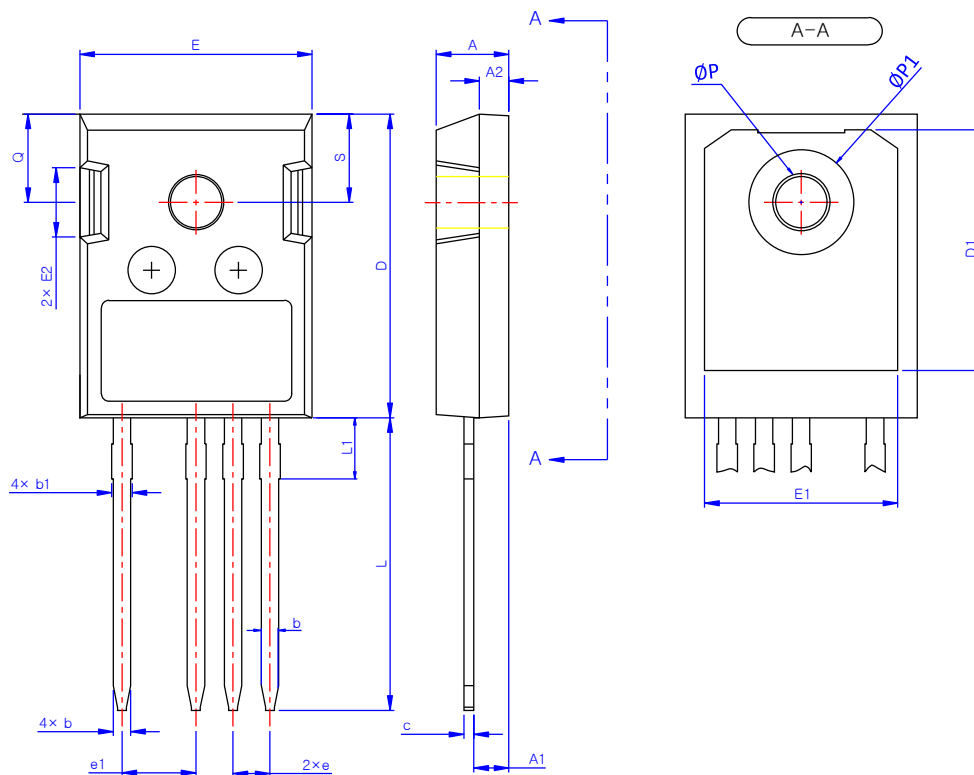


Figure 18. Transient Thermal Response Curve



Package Outlines TO-247-4L



SYMBOL	MIN	MAX
A	4.80	5.20
A1	2.29	2.54
A2	1.90	2.10
b	1.10	1.30
b1	1.30	1.50
c	0.50	0.70
D	20.80	21.34
D1	17.43	17.83
E	15.75	16.13
E1	13.06	13.46
E2	4.32	4.83
e	2.54 BSC	
e1	5.08 BSC	
L	19.85	20.25
L1	-	4.49
$\varnothing P$	3.55	3.65
$\varnothing P1$	7.00	7.40
Q	5.59	6.19
S	6.15 BSC	

*Dimensions in millimeters

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